



Attorney Docket No.: 56937-043
PATENT

#13/Amend B
A70ed
6/19/0

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of :
Satoru TOMEKAWA, et al. : Group Art Unit: 2822
Serial No.: 09/998,327 : Examiner: Monica LEWIS
Filed: December 03, 2001 :
For: CIRCUIT SUBSTRATE AND MANUFACTURING METHOD THEREOF

AMENDMENT UNDER 37 C.F.R. §1.111

Mail Stop Non-Fee Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

RECEIVED
JUN 16 2003
TECHNOLOGY CENTER 2800

In response to the Office Action dated April 4, 2003, having a shortened statutory period for response set to expire July 4, 2003, please amend the above-identified application as follows:

IN THE CLAIMS:

Please amend claims 2, 4, 6, 7 and 9 as follows:

2. (Twice Amended) The circuit substrate according to claim 1, wherein said conductor contains a resin composition, and a glass transition temperature of the resin composition is set lower than a glass transition temperature of a resin composition [constituting a surface site of] contained in said insulating base.